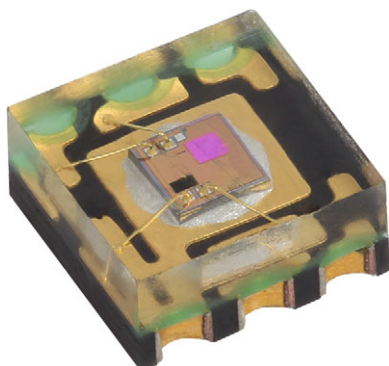


# Low Power, High Sensitivity, I<sup>2</sup>C Ambient Light Sensor



## DESCRIPTION

VEML3235 is an advanced ambient light sensor with I<sup>2</sup>C protocol interface and is designed by the CMOS process. It is easy to operate via a simple I<sup>2</sup>C command.

VEML3235 incorporates a photodiode, amplifiers, and analog circuits in a single chip. The best spectral sensitivity is used to closely capture real human eye responses. VEML3235 has excellent temperature compensation and the robust refresh rate setting does not need an external RC low pass filter. Software shutdown mode is provided, which reduces power consumption to be less than 1  $\mu$ A. VEML3235's operating voltage ranges from 2.6 V to 3.6 V. VEML3235 can detect a wide range of ambient light power.

## FEATURES

- Package type: surface-mount
- Dimensions (L x W x H in mm): 2 x 2 x 0.87
- Integrated modules: ambient light sensor (ALS)
- Supply voltage range V<sub>DD</sub>: 2.6 V to 3.6 V
- Communication via I<sup>2</sup>C interface
- I<sup>2</sup>C bus H-level range: 1.7 V to 3.6 V
- Floor life: 168 h, MSL 3, according to J-STD-020
- Low stand by current consumption: typ. 1  $\mu$ A
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



## APPLICATIONS

- Handheld device
- Notebook
- Consumer device
- Industrial and medical application
- Computing, and industrial devices and displays

## AMBIENT LIGHT FUNCTION

- High ALS sensitivity with minimum detectable intensity of 0.0021 lx/cnt supports low transmittance lens design
- Excellent temperature compensation
- High dynamic detection resolution
- Software shutdown mode control

## PRODUCT SUMMARY

| PART NUMBER | OPERATING VOLTAGE RANGE (V) | I <sup>2</sup> C BUS VOLTAGE RANGE (V) | AMBIENT LIGHT RANGE (lx) | AMBIENT LIGHT RESOLUTION (lx) | OUTPUT CODE              | ADC RESOLUTION PROXIMITY / AMBIENT LIGHT |
|-------------|-----------------------------|----------------------------------------|--------------------------|-------------------------------|--------------------------|------------------------------------------|
| VEML3235    | 2.6 to 3.6                  | 1.7 to 3.6                             | 0.0021 to 17 867         | 0.0021                        | 16 bit, I <sup>2</sup> C | - / 16 bit                               |

## ORDERING INFORMATION

| ORDERING CODE | PACKAGING     | VOLUME <sup>(1)</sup> | REMARKS                     |
|---------------|---------------|-----------------------|-----------------------------|
| VEML3235      | Tape and reel | MOQ: 3000             | 2.00 mm x 2.00 mm x 0.87 mm |

### Note

<sup>(1)</sup> MOQ: minimum order quantity

| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |                |           |      |      |                    |
|--------------------------------------------------------------------------------------------------------|----------------|-----------|------|------|--------------------|
| PARAMETER                                                                                              | TEST CONDITION | SYMBOL    | MIN. | MAX. | UNIT               |
| Supply voltage                                                                                         |                | $V_{DD}$  | 0    | 4    | V                  |
| Operation temperature range                                                                            |                | $T_{amb}$ | -25  | +85  | $^{\circ}\text{C}$ |
| Storage temperature range                                                                              |                | $T_{stg}$ | -25  | +85  | $^{\circ}\text{C}$ |

| <b>BASIC CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |                           |                     |      |        |      |               |
|-----------------------------------------------------------------------------------------------------|---------------------------|---------------------|------|--------|------|---------------|
| PARAMETER                                                                                           | TEST CONDITION            | SYMBOL              | MIN. | TYP.   | MAX. | UNIT          |
| Supply voltage                                                                                      |                           | $V_{DD}$            | 2.6  | 3.3    | 3.6  | V             |
| Shut down current <sup>(1)</sup>                                                                    | $V_{DD}$ is 3.3 V         | $I_{sd}$            | -    | 1      | -    | $\mu\text{A}$ |
| Supply current <sup>(1)</sup>                                                                       | $V_{DD}$ is 3.3 V         | $I_{DD}$            | -    | 250    | -    | $\mu\text{A}$ |
| I <sup>2</sup> C clock rate range                                                                   |                           | $f_{SCL}$           | 10   | -      | 400  | kHz           |
| I <sup>2</sup> C bus input H-level range                                                            | $V_{DD}$ is 3.3 V         | $V_{ih}$            | 1.2  | -      | -    | V             |
| I <sup>2</sup> C bus input L-level range                                                            | $V_{DD}$ is 3.3 V         | $V_{il}$            | 0    | -      | 0.4  | V             |
| Digital resolution (LSB count) <sup>(2)</sup>                                                       | With DG = x 2, Gain = x 4 |                     | -    | 0.0021 | -    | lx/step       |
| Detectable minimum illuminance <sup>(2)</sup>                                                       | With DG = x 2, Gain = x 4 | $E_{V\text{ min.}}$ | -    | 0.0021 | -    | lx            |
| Detectable maximum illuminance <sup>(3)</sup>                                                       | With DG = x 1, Gain = x 1 | $E_{V\text{ max.}}$ | -    | 17 867 | -    | lx            |

**Notes**

<sup>(1)</sup>  $V_{DD} = 3.3\text{ V}$ , temperature:  $25\text{ }^{\circ}\text{C}$

<sup>(2)</sup>  $IT = 800\text{ ms}$

<sup>(3)</sup>  $IT = 50\text{ ms}$

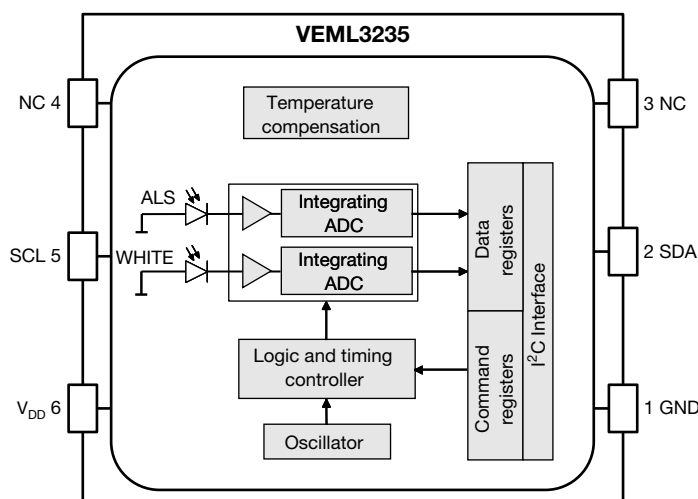
**CIRCUIT BLOCK DIAGRAM**


Fig. 1 - Block Diagram

| <b>I<sup>2</sup>C TIMING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |                |                              |      |                          |      |               |
|---------------------------------------------------------------------------------------------------------------------|----------------|------------------------------|------|--------------------------|------|---------------|
| PARAMETER                                                                                                           | SYMBOL         | STANDARD MODE <sup>(1)</sup> |      | FAST MODE <sup>(1)</sup> |      | UNIT          |
|                                                                                                                     |                | MIN.                         | MAX. | MIN.                     | MAX. |               |
| Clock frequency                                                                                                     | $f_{(SMBCLK)}$ | 10                           | 100  | 10                       | 400  | kHz           |
| Bus free time between start and stop condition                                                                      | $t_{(BUF)}$    | 4.7                          | -    | 1.3                      | -    | $\mu\text{s}$ |
| Hold time after (repeated) start condition; after this period, the first clock is generated                         | $t_{(HDSTA)}$  | 4.0                          | -    | 0.6                      | -    | $\mu\text{s}$ |
| Repeated start condition setup time                                                                                 | $t_{(SUSTA)}$  | 4.7                          | -    | 0.6                      | -    | $\mu\text{s}$ |
| Stop condition setup time                                                                                           | $t_{(SUSTO)}$  | 4.0                          | -    | 0.6                      | -    | $\mu\text{s}$ |
| Data hold time                                                                                                      | $t_{(HDDAT)}$  | -                            | 3450 | -                        | 900  | ns            |
| Data setup time                                                                                                     | $t_{(SUDAT)}$  | 250                          | -    | 100                      | -    | ns            |
| I <sup>2</sup> C clock (SCL) low period                                                                             | $t_{(LOW)}$    | 4.7                          | -    | 1.3                      | -    | $\mu\text{s}$ |
| I <sup>2</sup> C clock (SCL) high period                                                                            | $t_{(HIGH)}$   | 4.0                          | -    | 0.6                      | -    | $\mu\text{s}$ |
| Clock / data fall time                                                                                              | $t_{(F)}$      | -                            | 300  | -                        | 300  | ns            |
| Clock / data rise time                                                                                              | $t_{(R)}$      | -                            | 1000 | -                        | 300  | ns            |

**Note**

<sup>(1)</sup> Data based on standard I<sup>2</sup>C protocol requirement, not tested in production

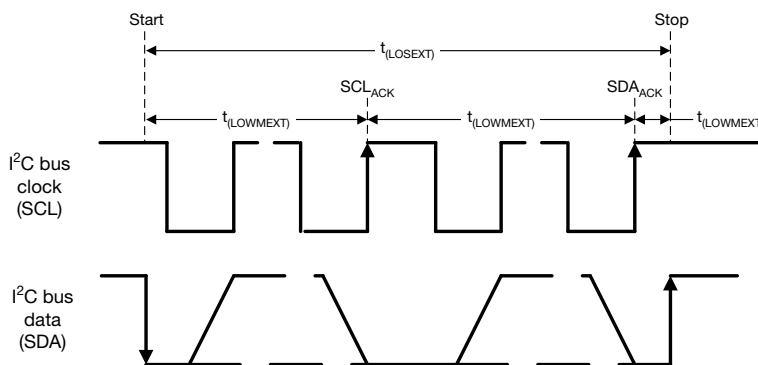
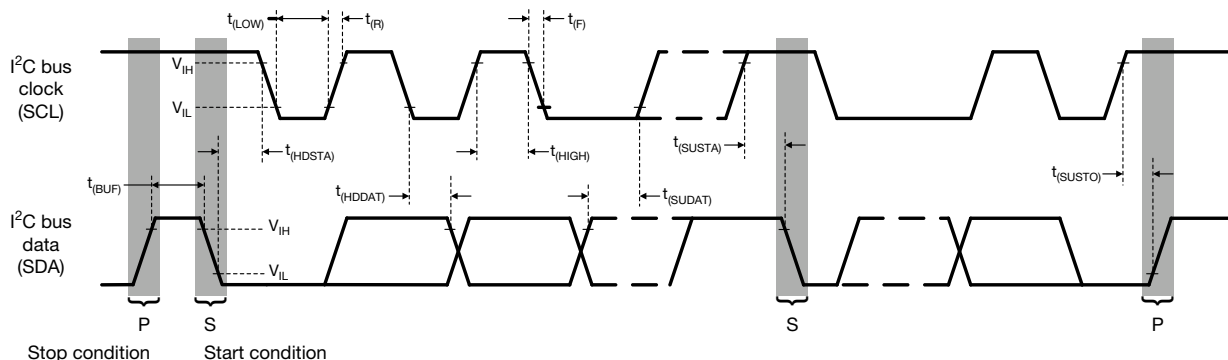


Fig. 2 - I<sup>2</sup>C Timing Diagram

## PARAMETER TIMING INFORMATION

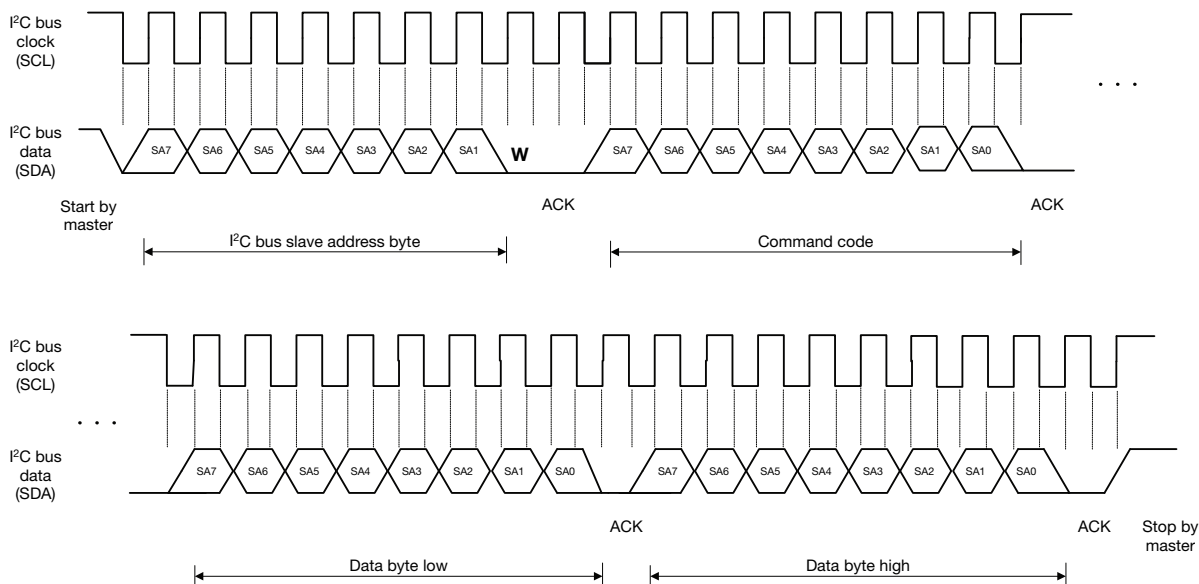


Fig. 3 - I<sup>2</sup>C Bus Timing for Sending Word Command Format

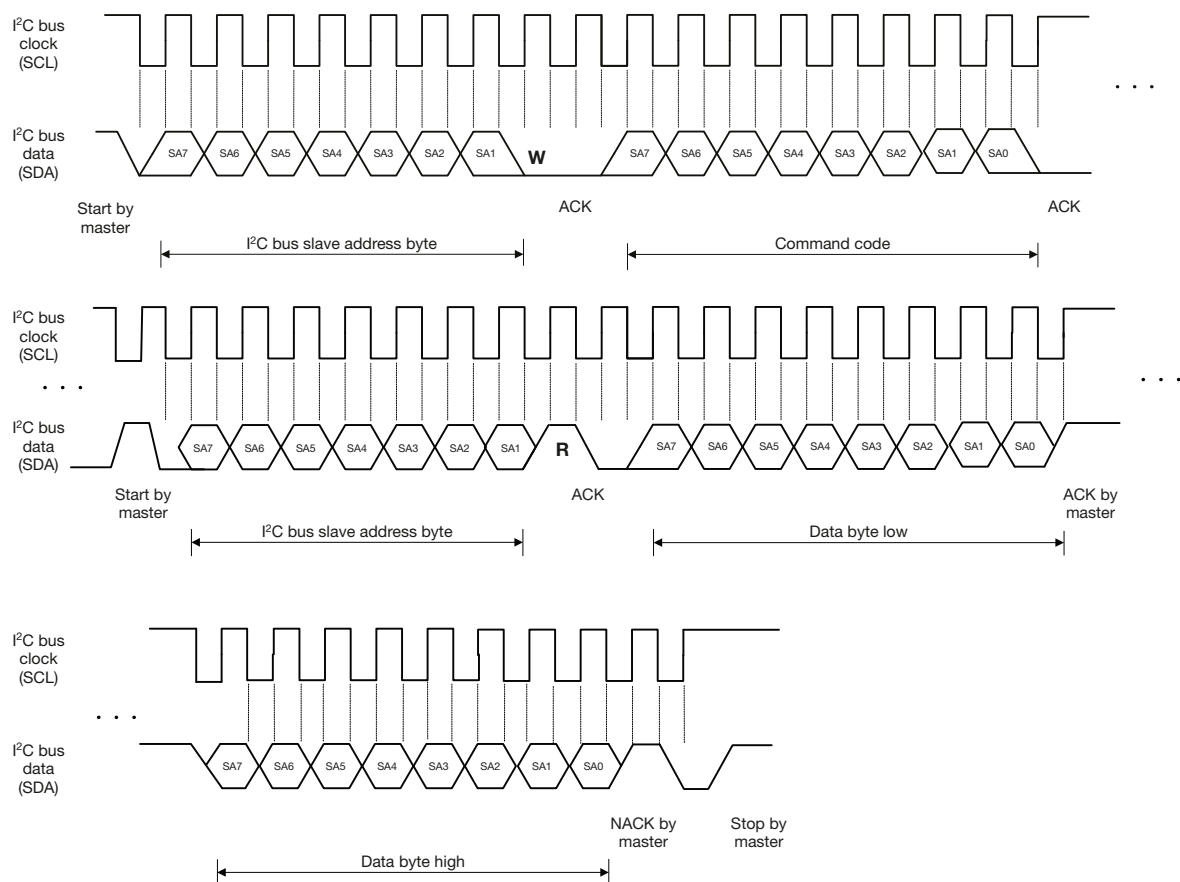


Fig. 4 - I<sup>2</sup>C Bus Timing for Receive Word Command Format

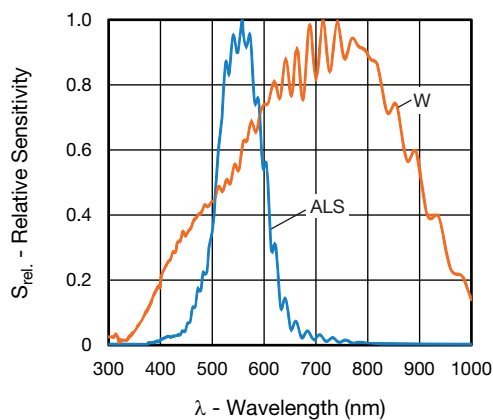
**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

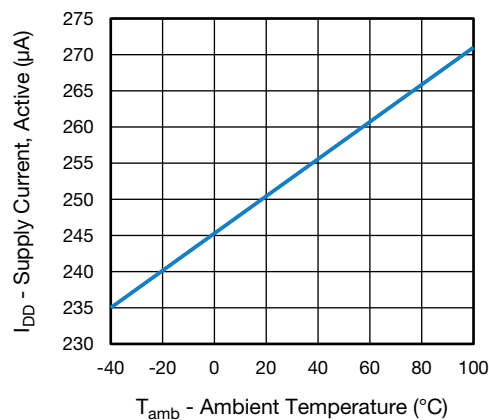


Fig. 7 - Supply Current vs. Ambient Temperature

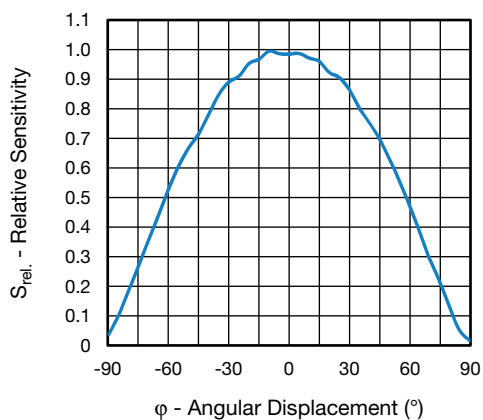


Fig. 6 - Relative Sensitivity vs. Angular Displacement

## APPLICATION INFORMATION

### 1. Pin Connection With the Host

VEML3235 is a cost effective solution with I<sup>2</sup>C interface. The standard serial digital interface easily accesses “light intensity” without using complex calculations and programming by an external controller.

The additional capacitor near the V<sub>DD</sub> pin in the circuit is used for power supply noise rejection. The value is recommended at 0.1 μF. The pull-up resistors for the I<sup>2</sup>C bus design are recommended to be 2.2 kΩ.

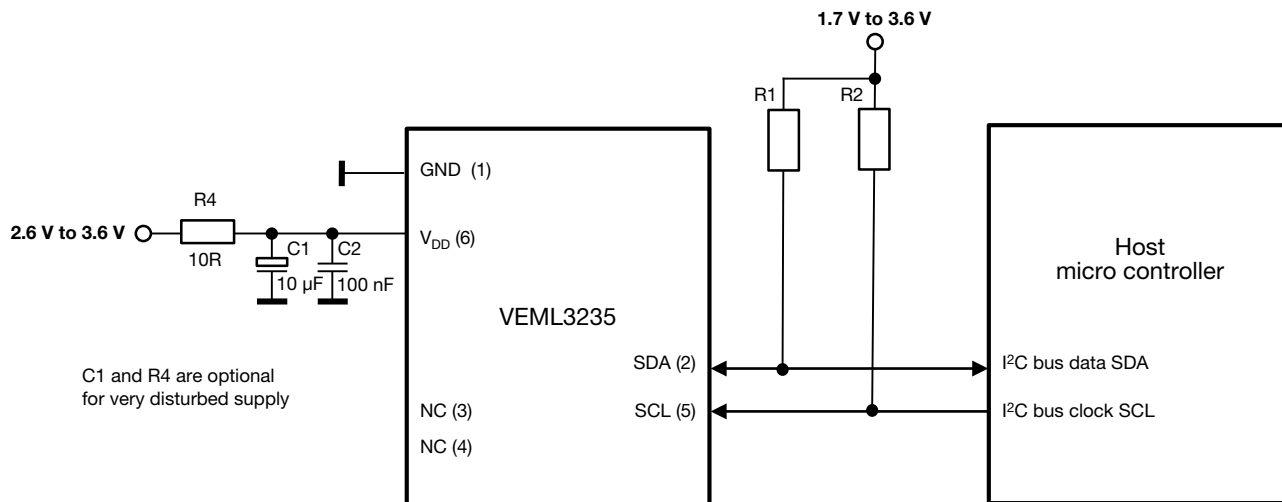
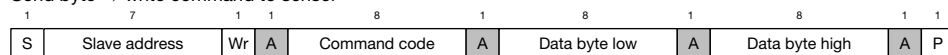


Fig. 8 - Hardware Pin Connection Diagram (Slave Address 0x10)

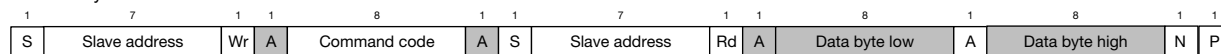
### Digital Interface

VEML3235 contains a command register written via the I<sup>2</sup>C bus. All operations can be controlled by the command register. The simple command structure allows the user to easily program the operation setting and latch the light data from VEML3235. VEML3235's I<sup>2</sup>C command format description for read and write operations between VEML3235 and the host is shown in Fig. 9. The white areas indicate the host activity and the gray areas indicate VEML3235's acknowledgement of the host access activity.

Send byte → write command to sensor



Receive byte → read data from VEML3235



S = start condition

P = stop condition

A = acknowledge

N = not acknowledge

☐ Host action

☒ Sensor acknowledge

Fig. 9 - Command Protocol Format

**Command Register Format**

VEML3235 uses 0x10 slave address for 7-bit I<sup>2</sup>C addressing protocol. VEML3235 has 16-bit resolution for each channel (ALS and W).

**TABLE 1 - COMMAND CODE DESCRIPTION**

| COMMAND CODE | REGISTER NAME | DATE BYTE LOW / HIGH | BIT   | FUNCTION DESCRIPTION                                                                                                                                  | R / W |
|--------------|---------------|----------------------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| 0x00         | Reserved      | L                    | 7     | Set 0                                                                                                                                                 | R / W |
|              | ALS/W_IT      |                      | 6 : 4 | ALS/W integration time setting<br>(0 : 0 : 0) = 50 ms<br>(0 : 0 : 1) = 100 ms<br>(0 : 1 : 0) = 200 ms<br>(0 : 1 : 1) = 400 ms<br>(1 : 0 : 0) = 800 ms |       |
|              | Reserved      |                      | 3 : 1 | Set 0                                                                                                                                                 |       |
|              | SD            |                      | 0     | Shutdown BG and LDO with SD = 1 (default)                                                                                                             |       |
|              | SD0           | H                    | 7     | Shutdown ALS and white channel with SD0 = 1 (default)                                                                                                 |       |
|              | Reserved      |                      | 6     | Set 0                                                                                                                                                 |       |
|              | DG            |                      | 5     | 0 = x 1, 1 = x 2                                                                                                                                      |       |
|              | Gain          |                      | 4 : 3 | (0 : 0) = x 1<br>(0 : 1) = x 2<br>(1 : 0) = reserved<br>(1 : 1) = x 4                                                                                 |       |
|              | Reserved      |                      | 2 : 1 | Set 0                                                                                                                                                 |       |
|              | Reserved      |                      | 0     | Set 1                                                                                                                                                 |       |
| 0x02         | Reserved      | L                    | 7 : 0 | Set 0                                                                                                                                                 | R     |
|              | Reserved      | H                    | 7 : 0 | Set 0                                                                                                                                                 |       |
| 0x04         | W_LSB         | L                    | 7 : 0 | W LSB data                                                                                                                                            |       |
|              | W_MSB         | H                    | 7 : 0 | W MSB data                                                                                                                                            |       |
| 0x05         | ALS_LSB       | L                    | 7 : 0 | ALS LSB data                                                                                                                                          |       |
|              | ALS_MSB       | H                    | 7 : 0 | ALS MSB data                                                                                                                                          |       |
| 0x09         | ID_L          | L                    | 7 : 0 | ID part number: 3235 = 0011 0101                                                                                                                      |       |
|              | Reserved      | H                    | 7 : 0 | Reserved                                                                                                                                              |       |

**Data Access**

VEML3235 has 16-bit high resolution sensitivity for each channel. To represent the 16-bit data, it has to apply two bytes. One byte is for LSB and the other byte is for MSB. The host needs to follow the read word protocol. The data format shows as below.

| TABLE 2 - 16-BIT DATA FORMAT |    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|------------------------------|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| VEML3235 16-BIT DATA FORMAT  |    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| Data bit                     | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Data byte low                |    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| Data byte high               |    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**Note**

|   |               |    |   |              |   |   |               |    |   |               |   |                |   |   |
|---|---------------|----|---|--------------|---|---|---------------|----|---|---------------|---|----------------|---|---|
| S | Slave address | Wr | A | Command code | A | S | Slave address | Rd | A | Data byte low | A | Data byte high | N | P |
|---|---------------|----|---|--------------|---|---|---------------|----|---|---------------|---|----------------|---|---|

- Data byte low represents LSB and data byte high represents MSB

The table below shows these dependencies:

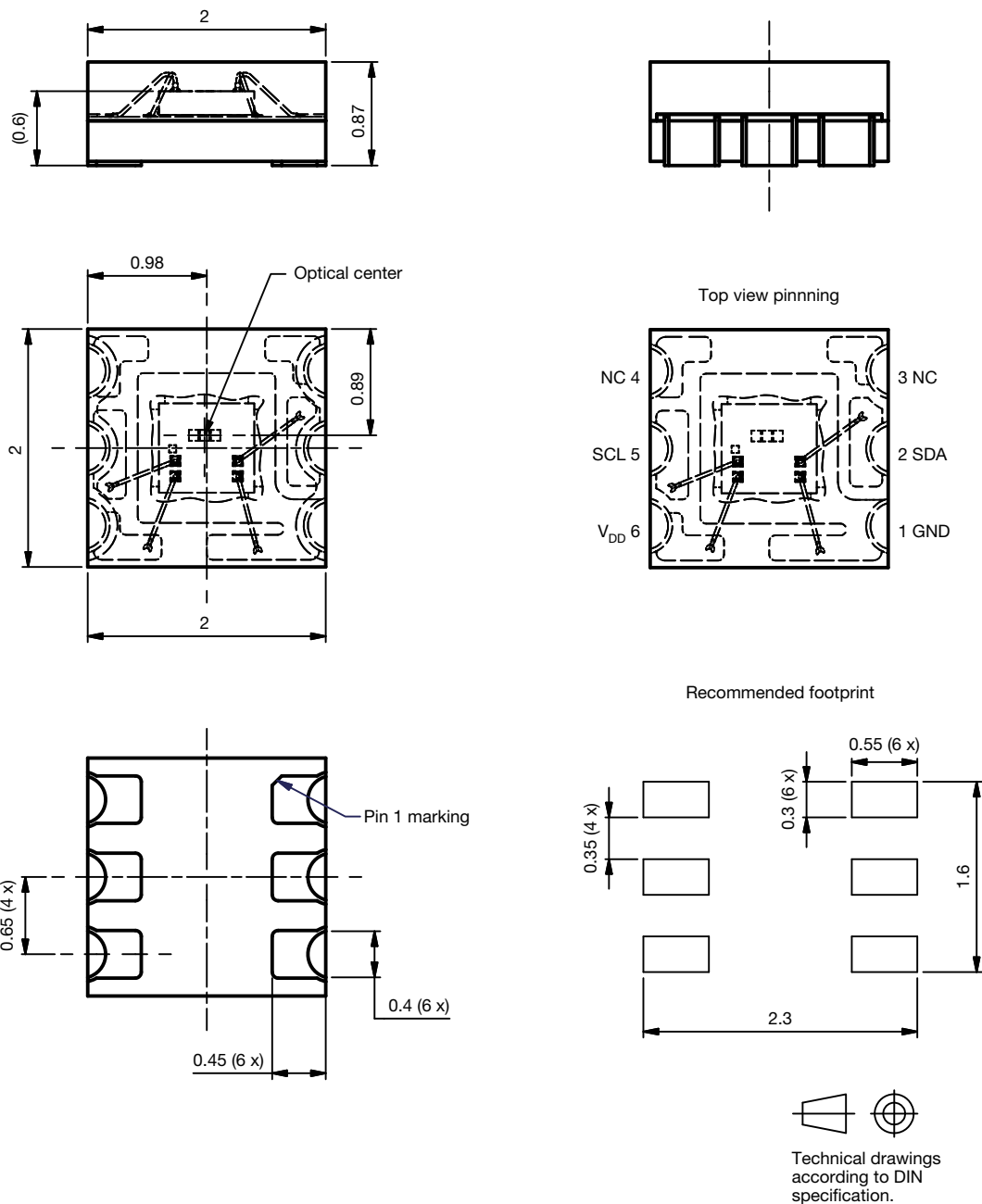
| RESOLUTION AND MAXIMUM DETECTION RANGE AT DG = 1 |                             |           |           |  |                                    |           |           |  |  |
|--------------------------------------------------|-----------------------------|-----------|-----------|--|------------------------------------|-----------|-----------|--|--|
|                                                  | GAIN: x 4                   | GAIN: x 2 | GAIN: x 1 |  | GAIN: x 4                          | GAIN: x 2 | GAIN: x 1 |  |  |
| IT (ms)                                          | TYPICAL RESOLUTION (lx/cnt) |           |           |  | MAXIMUM POSSIBLE ILLUMINATION (lx) |           |           |  |  |
| 800                                              | 0.00426                     | 0.00852   | 0.01704   |  | 279                                | 558       | 1117      |  |  |
| 400                                              | 0.00852                     | 0.01704   | 0.03408   |  | 558                                | 1117      | 2233      |  |  |
| 200                                              | 0.01704                     | 0.03408   | 0.06816   |  | 1117                               | 2233      | 4467      |  |  |
| 100                                              | 0.03408                     | 0.06816   | 0.13632   |  | 2233                               | 4467      | 8934      |  |  |
| 50                                               | 0.06816                     | 0.13632   | 0.27264   |  | 4467                               | 8934      | 17 867    |  |  |

| RESOLUTION AND MAXIMUM DETECTION RANGE AT DG = 2 |                             |           |           |  |                                    |           |           |  |  |
|--------------------------------------------------|-----------------------------|-----------|-----------|--|------------------------------------|-----------|-----------|--|--|
|                                                  | GAIN: x 4                   | GAIN: x 2 | GAIN: x 1 |  | GAIN: x 4                          | GAIN: x 2 | GAIN: x 1 |  |  |
| IT (ms)                                          | TYPICAL RESOLUTION (lx/cnt) |           |           |  | MAXIMUM POSSIBLE ILLUMINATION (lx) |           |           |  |  |
| 800                                              | 0.00213                     | 0.00426   | 0.00852   |  | 140                                | 279       | 558       |  |  |
| 400                                              | 0.00426                     | 0.00852   | 0.01704   |  | 279                                | 558       | 1117      |  |  |
| 200                                              | 0.00852                     | 0.01704   | 0.03408   |  | 558                                | 1117      | 2233      |  |  |
| 100                                              | 0.01704                     | 0.03408   | 0.06816   |  | 1117                               | 2233      | 4467      |  |  |
| 50                                               | 0.03408                     | 0.06816   | 0.13632   |  | 2233                               | 4467      | 8934      |  |  |

Example:

If the 16-bit word of the ALS data shows: 0000 0101 1100 1000 = 1480 (dec.), the programmed Gain = x 1, the digital gain DG = x 1 and the integration time is 100 ms, the corresponding lux level is: light level [lx] = 1480 x 0.13632 = 202 lx.

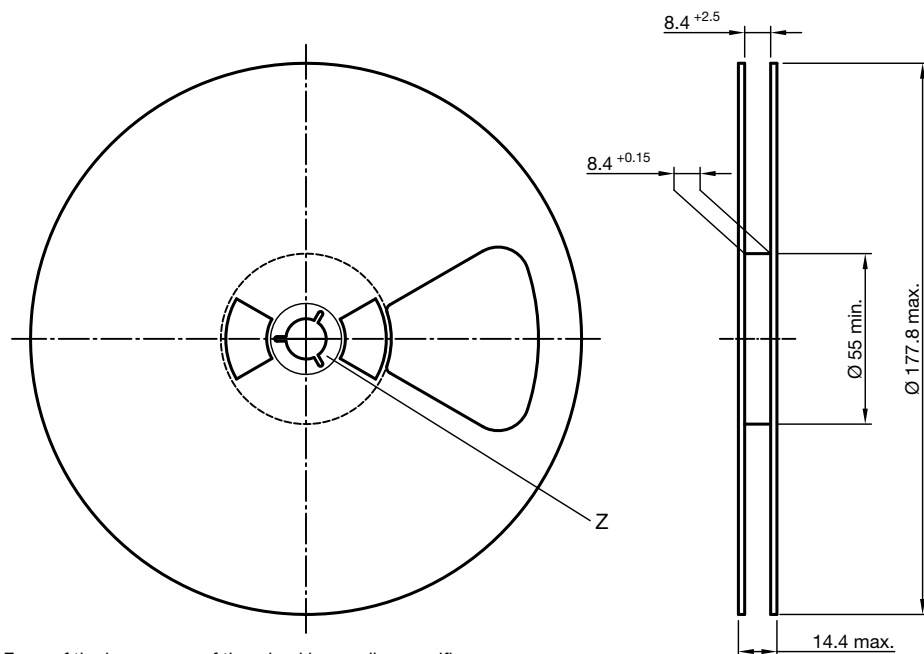
For detailed description about set-up and more application related information see application note: "Designing VEML3235 into an Application".

**PACKAGE INFORMATION** in millimeters


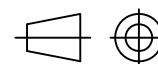
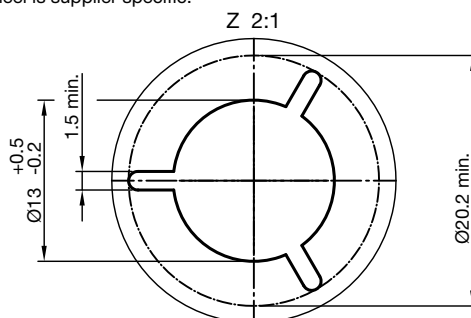
Drawing No.: 6.541-5122-01-4  
Issue: 1; 08.11.2019

Not indicated tolerances  $\pm 0.1$

Fig. 10 - VEML3235 A3OZ Package Dimensions

**TAPE AND REEL DIMENSIONS** in millimeters


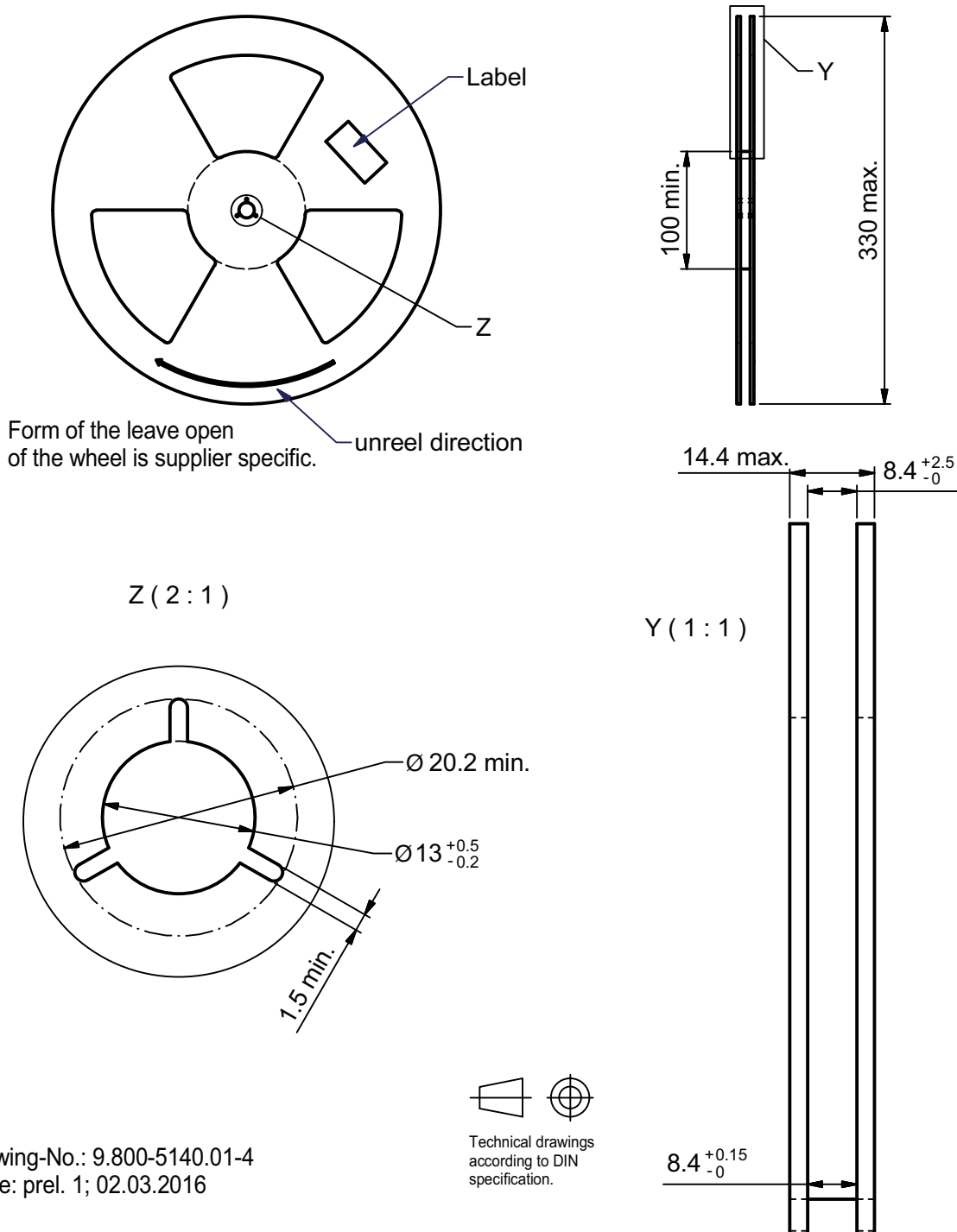
Form of the leave open of the wheel is supplier specific.



Technical drawings  
according to DIN  
specification.

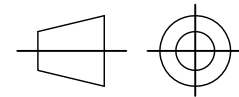
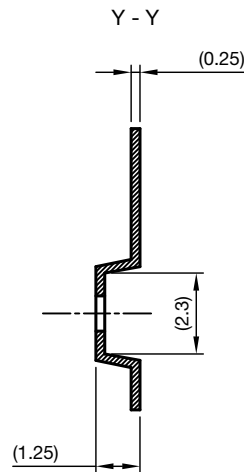
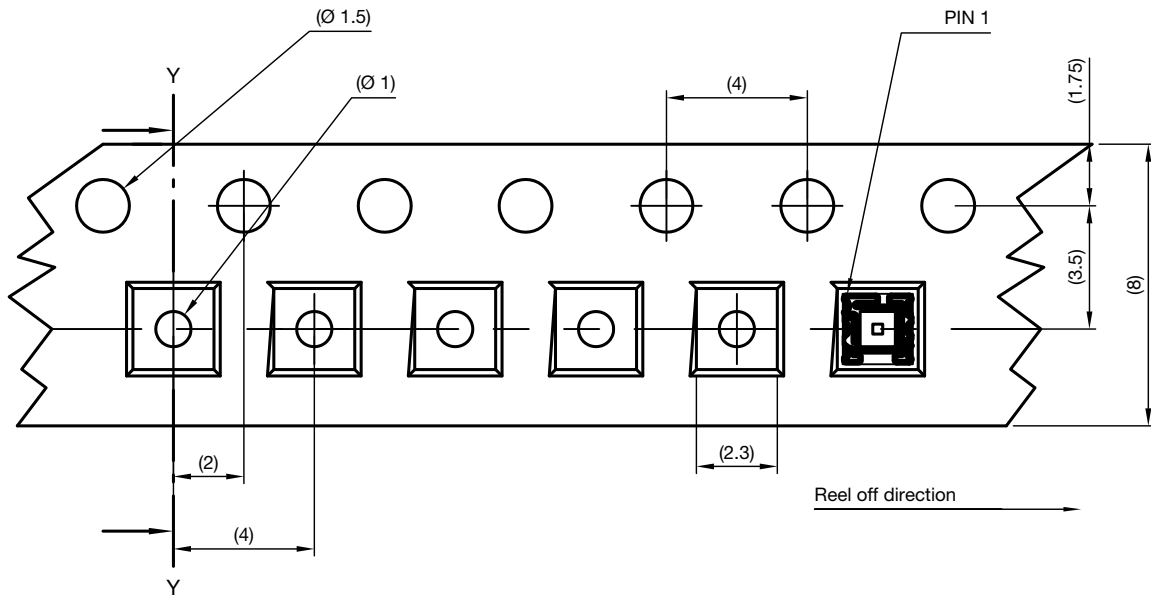
Drawing-No.: 9.800-5096.01-4  
Issue: 6; 20.03.2019

Fig. 11 - 7" Reel, 3000 Pieces



Drawing-No.: 9.800-5140.01-4  
Issue: prel. 1; 02.03.2016

Fig. 12 - 13" Reel, 10 000 Pieces



technical drawings  
according to DIN  
specifications

Drawing-No.: 9.700-5397.01-4  
Issue: 1; 19.02.16

Fig. 13 - Taping



### RECOMMENDED STORAGE AND REBAKING CONDITIONS

| PARAMETER           | CONDITIONS                                               | MIN. | MAX. | UNIT   |
|---------------------|----------------------------------------------------------|------|------|--------|
| Storage temperature |                                                          | 5    | 50   | °C     |
| Relative humidity   |                                                          | -    | 60   | %      |
| Open time           |                                                          | -    | 168  | h      |
| Total time          | From the date code on the aluminized envelope (unopened) | -    | 12   | months |
| Rebaking            | Tape and reel: 60 °C                                     | -    | 22   | h      |
|                     | Tube: 60 °C                                              | -    | 22   | h      |

### RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020 C

### IR REFLOW PROFILE CONDITION

| PARAMETER                                  | CONDITIONS | TEMPERATURE                           | TIME          |
|--------------------------------------------|------------|---------------------------------------|---------------|
| Peak temperature                           |            | 255 °C + 0 °C / - 5 °C (max.: 260 °C) | 10 s          |
| Preheat temperature range and timing       |            | 150 °C to 200 °C                      | 60 s to 180 s |
| Timing within 5 °C to peak temperature     |            | -                                     | 10 s to 30 s  |
| Timing maintained above temperature / time |            | 217 °C                                | 60 s to 150 s |
| Timing from 25 °C to peak temperature      |            | -                                     | 8 min (max.)  |
| Ramp-up rate                               |            | 3 °C/s (max.)                         | -             |
| Ramp-down rate                             |            | 6 °C/s (max.)                         | -             |

Recommend Normal Solder Reflow is 235 °C to 255 °C

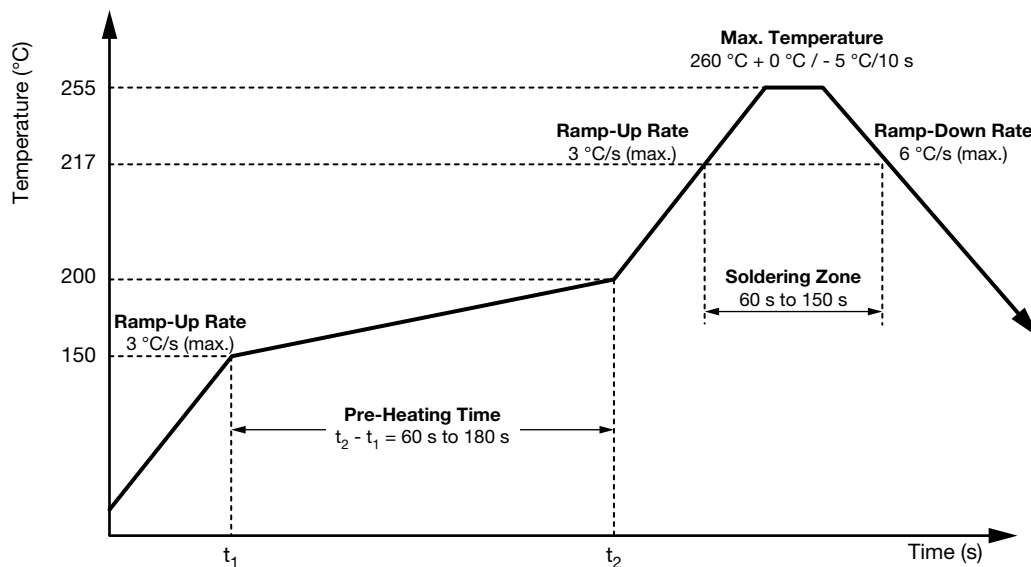


Fig. 14 - VEML3235SL Solder Reflow Profile Chart



#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ ,  $RH < 60\%$

Moisture sensitivity level 3, according to J-STD-020.

#### **DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at  $40\text{ }^{\circ}\text{C}$  (+  $5\text{ }^{\circ}\text{C}$ ),  $RH < 5\%$ .



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